

● Features

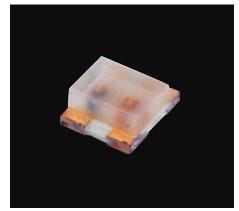
- 2-color type LED
- Abundant 2 color variations

●Size

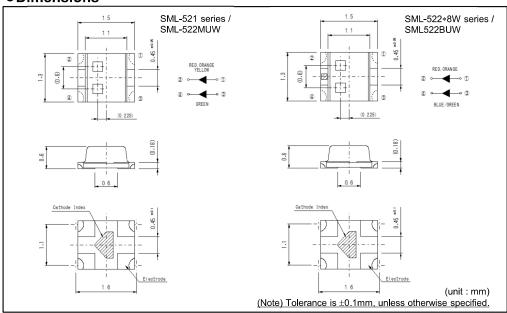
1315 (0605) 1.3 × 1.5mm (t=0.6mm)



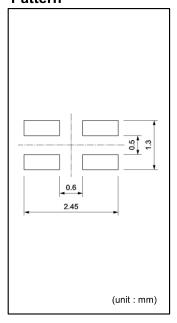
●Outline



Dimensions



Recommended Solder Pattern



Specifications

	Chip Structure	1 1	Absolute Maximum Ratings (Ta=25°C)						Electrical and Optical Characteristics (Ta=25°C)										
Part No.			Power	Forward	Peak Forward	Reverse	Operating Temp.	Storage Temp.	Forward	Forward Voltag V _F Reverse Current I _R Dominant Wavelength λD Luminous Inte							ous Inte	nsity I _V	
				n Current	Current				Тур.	I _F	Max.	V_R	Min.*3	Тур.	Max.*3	ΙF	Min.	Тур.	I _F
			$P_D(mW)$	$I_F(mA)$	$I_{FP}(mA)$	$V_R(V)$	Topr(°C)	Tstg(°C)	(V)	(mA)	(μΑ)	(V)	(nm)	(nm)	(nm)	(mA)	(mcd)	(mcd)	(mA)
SML522BU1W	InGaN	Blue	66	20	60* ²	5	-40 to +85	-40 to +100	2.9	2.9 1.9 5	10	5	465	470	475	5	9	22	5
	AlGalnP	Red	50	20									619	624	629		10	21	ľ
CAN FOORHUM		Yellowish Green	52	60* ¹	00.1		-30 to +85	-40 to +85	2.1				569	572	575	``	14	40	
SML-522MUW	AlGalnP	Red	50		60*				1.9	Ī			615	620	625		22	63	İ
SML-522MU8W		Green 54	20	400*2	1	40.405	40.4400	0.0				569	572	575	[16	40		
			54	'	100* ²	4	-40 to +85	-40 to +100	2.2	20 100			615	620	625	5	25	63]
CMI FOAMINA	GaP	Yellowish Green	70	25 20	00*1	60* ¹	-30 to +85	-40 to +85	2.2			569	572	575		5.6	16]	
SML-521MUW	AlGalnP	Red	50		60"				1.9		100	4	615	620	625	20	22	63	20
SMI ESSMEN	AlGalnP	P Green 54	ΕΛ	20	100*2	5	-40 to +85	-40 to +100	2.2		100	4	569	572	575	20	10	25	
SIVIL-522IVIDOVV			54	54 20									602	605	608		40	100	
SML-521MDW	GaP	Yellowish Green	70	25 20 25			-30 to +85	-40 to +85	2.2				569	572	575		5.6	16	
	AlGalnP	Orange	50		60* ¹	4			1.9	2			602	605	608		22	63	
SML-521MYW	GaP	Yellowish Green	70		60"				2.2				569	572	575		5.6	16	
	AlGalnP	Yellow	50	20					1.9				584	587	590		22	63	

Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

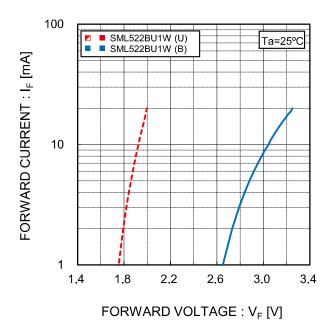


Fig.2 Luminous Intensity Atmosphere Temperature

1.8

1.4

SNOONIND

1 0.6

SML522BU1W (U)
SML522BU1W (B)

0.2

-40 -20 0 20 40 60 80 100

ATMOSPHERE TEMPERATURE: Ta [°C]

Fig.3 Luminous Intensity - Forward Current

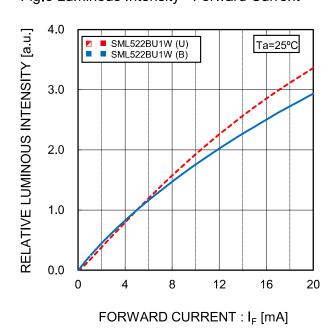
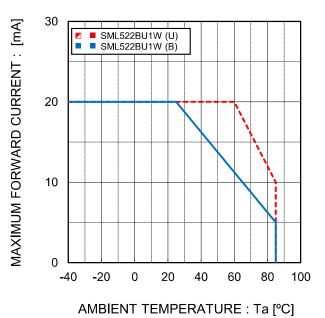


Fig.4 Derating



(Note) In case of lighting a single color.

*The value is based on the die destruction endurance; optical characteristics are NOT considered..

•Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

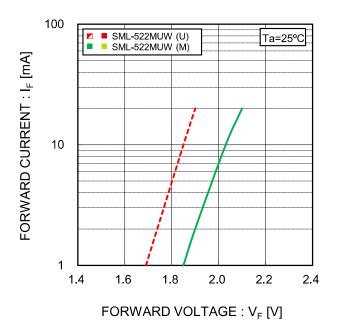


Fig.2 Luminous Intensity -Atmosphere Temperature 1.6 RELATIVE LUMINOUS INTENSITY [a.u.] I_F=20mA 1.4 1.2 8.0 0.6 SML-522MUW (U) SML-522MUW (M) 0.4 100 **-**40 -20 40 60 80

ATMOSPHERE TEMPERATURE: Ta [°C]

Fig.3 Luminous Intensity - Forward Current

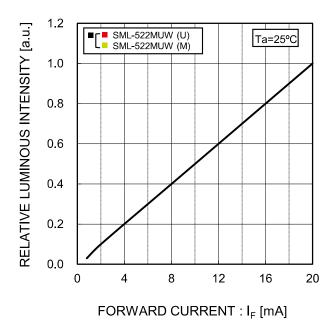
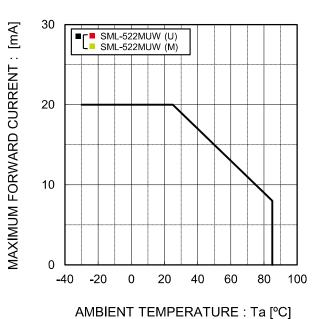


Fig.4 Derating



Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

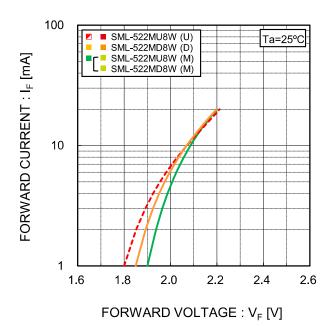


Fig.2 Luminous Intensity -Atmosphere Temperature 1.6 RELATIVE LUMINOUS INTENSITY [a.u.] I_F=20mA 1.4 1.2 8.0 SML-522MU8W (U) 0.6 ■ SML-522MD8W (D) SML-522MU8W (M) SML-522MD8W (M) 0.4 40 60 100 **-**40 -20 0 20 80

ATMOSPHERE TEMPERATURE: Ta [°C]

Fig.3 Luminous Intensity - Forward Current

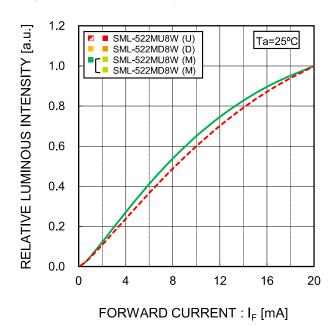
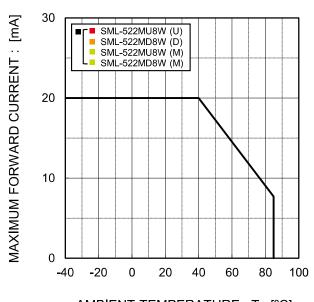


Fig.4 Derating



Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

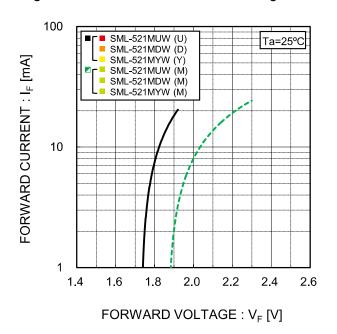
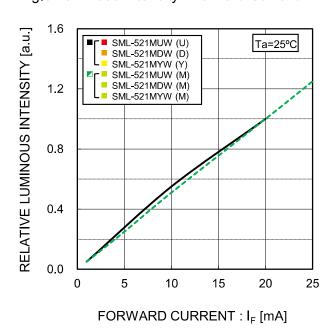


Fig.2 Luminous Intensity -Atmosphere Temperature 1.6 RELATIVE LUMINOUS INTENSITY [a.u.] $I_F=20mA$ 1.4 1.2 8.0 ■ **Г** ■ SML-521MUW (U) SML-521MDW (D) SML-521MYW (Y) 0.6 SML-521MUW (M) SML-521MDW (M) SML-521MYW (M) 0.4 -20 20 40 60 80 100 **-4**0

ATMOSPHERE TEMPERATURE: Ta [°C]

Fig.3 Luminous Intensity - Forward Current



MAXIMUM FORWARD CURRENT: [mA]

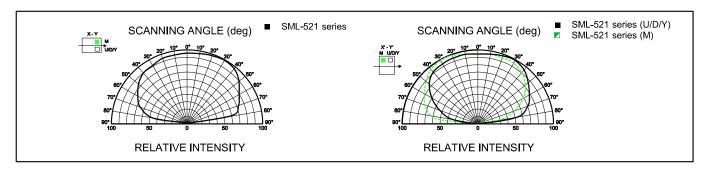
0

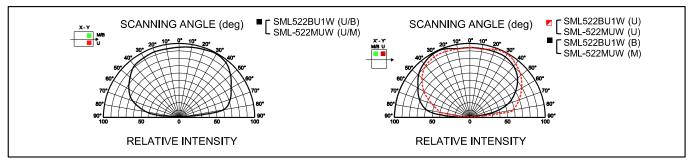
0

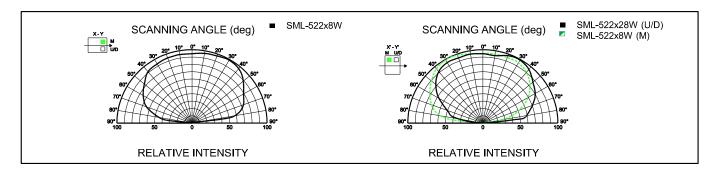
Fig.4 Derating

30 20 10 ■ SML-521MUW (U) SML-521MDW (D) SML-521MYW (Y) SML-521MUW (M) SML-521MDW (M) SML-521MYW (M) 0 -20 100 -40 40 60 80

Viewing Angle







Rank Reference of Brightness

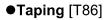
 $(Ta=25^{\circ}C, I_F=20mA)$

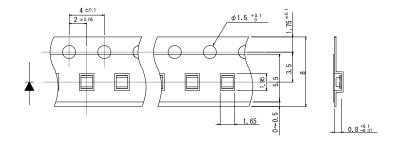
										(
Part No.	Rank	K	L	М	N	Р	Q	R	S	Τ	U
	Iv (mcd)	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	90 to 140	140 to 220	220 to 360
SML-522MUW*	Red						U				
	Yellowish Green				M						
SML-522MU8W*	Red					U					
	Green				M						
SML-521MUW*	Red						U				
	Yellowish Green			М							
SML-522MD8W	Orange						D				
	Green			М							
SML-521MDW*	Orange							D			
	Yellowish Green	Yellowish Green		M							
SML-521MYW*	Yellow						Υ				
	Yellowish Green		M								

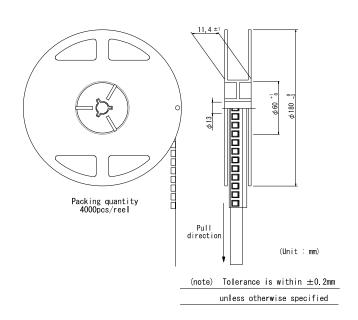
(Ta=25°C, I_F=5mA)

Part No.	Rank	K	L	M	N	Р	Q	R	S	Т	U
	lv (mcd)	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	90 to 140	140 to 220	220 to 360
SML522BU1W	Red				U						
	Blue				В						

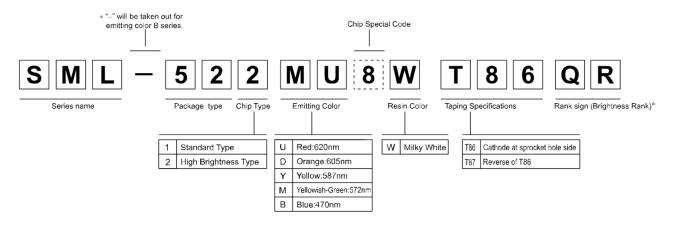
* Measurement tolerance ±10%







● Part No. Construction



- * Concerning the Brightness rank
- Please refer to the rank chart above for luminous intensity classification.
- Part name is individual for each rank.
- When shipped as sample, the part name will be a representative part name.
 General products are free of ranks. Please contact sales if rank appointment is needed.

Packing Specification

ROHM LED products are being shipped with desiccant (silica gel) concluded in moisture-proof bags.

Pasting the moisture sensitive label on the outer surface of the moisture-proof bags or enclosing the humidity indication card inside the bag is available upon request.

Please contact the nearest sales office or distributer if necessary.

Attention Points In Handling

This product was developed as a surface mount LED especially suitable for soldering.

Please take care of following points when using this device.

1.DESIGNING OF PCB

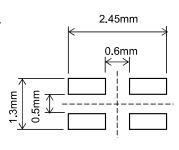
As for a recommendable solder pattern, Please refer to Fig-1.

The size and direction of the pad pattern depend on the condition of the PCB.

Thorough design review is recommended before the final designing

This product of structured with rear/bottom electrode to be soldered.

The formation of solder fillet is not guaranteed due to its electrode shape.



(Fig-1)

2.SOLDERING (Sn-Cu, Sn-Ag-Cu, Sn-Ag-Bi-Cu)

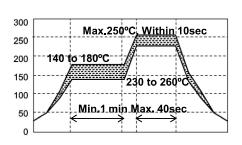
LED products do not contain reinforcement materials such as glass fillers.

Therefore, thermal stress by soldering greatly influence its reliability.

The temperature conditions for reflow soldering should therefore be set up according to the characteristic of this product. (See Fig-2)

Number of reflow process shall be max 2 times and these processes shall be performed in a row.

Cooling process to normal temperature shall be required between first and second soldering process.



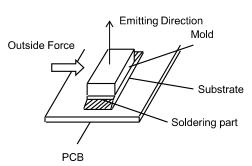
(Fig-2)

3.HANDLING AFTER MOUNTING

As shown right drawing, in case outside force of around 1kg is given to the device, stress is concentrated to the jointed part between mold resin and substrate.

Therefore there is a possibility to breat the device or PCB.

Careful handing is needed as ROHM cannot guarantee the falling of the device by outside force after mounting.



4.WASHING

Please note the following points when washing is required after soldering.

4-1) WASHING SOLVENT

Isopropyl alcohol or other alcohol solvent is recommendable.

4-2) TEMPERATURE

Below 30°C, immersion time; within 3 minutes.

4-3) ULTRA SONIC WASHING

Below 15/1 litter of solvent tub.

4-4) COOLING

Below 100°C within 3 minutes.

5.EROSION GAS

Utilization in erosion gas atmosphere may degenerate the plating surface which might cause deterioration of solder strength, optical characteristics, or functions.

Please take precautions against occurrence of gas from the surrounding parts on the occasion of custody, and also after mounted on circuit board.

6.STORAGE

At reflow soldering, the reliability of this product is often influenced by moisturet absorption so we apply the packaging with moisture proof for better condition is use, please also note that 6-1) Not to be opened before using.

6-2) To be kept in our moisture proof packaging with some desiccant (SILICA GEL) after opening it.

To be baked in case the SILICA GEL indicator changed its color from either blue to clear or green to pink.

6-3) Please use within 168 hours after the package was opened. (Condition at 30°C, max.70%Rh.)

In case it is not used within 168 hours, please put it back into our packaging.

6-4) BAKING

Please bake under reel condition at 60°C, 12~24 hours (max.20%Rh) after un-sealing.

While baking is done, the reel and emboss tape may be easily deformed.

Please be careful not to give any stress.

7.LIFE TIME

This product will cause reduction of luminous intensity depending on the using conditions and environmental.

Please inquire our sales contact if long life time is required on your application.

Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications:
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.

 Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products are intended for use in general electronic equipment (i.e. AV/OA devices, communication, consumer systems, gaming/entertainment sets) as well as the applications indicated in this document.
- 7) The Products specified in this document are not designed to be radiation tolerant.
- 8) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative: transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
- Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 10) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 11) ROHM has used reasonable care to ensur the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
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